

PowerMOS transistor

BUK457-400A
BUK457-400B

T-39-13

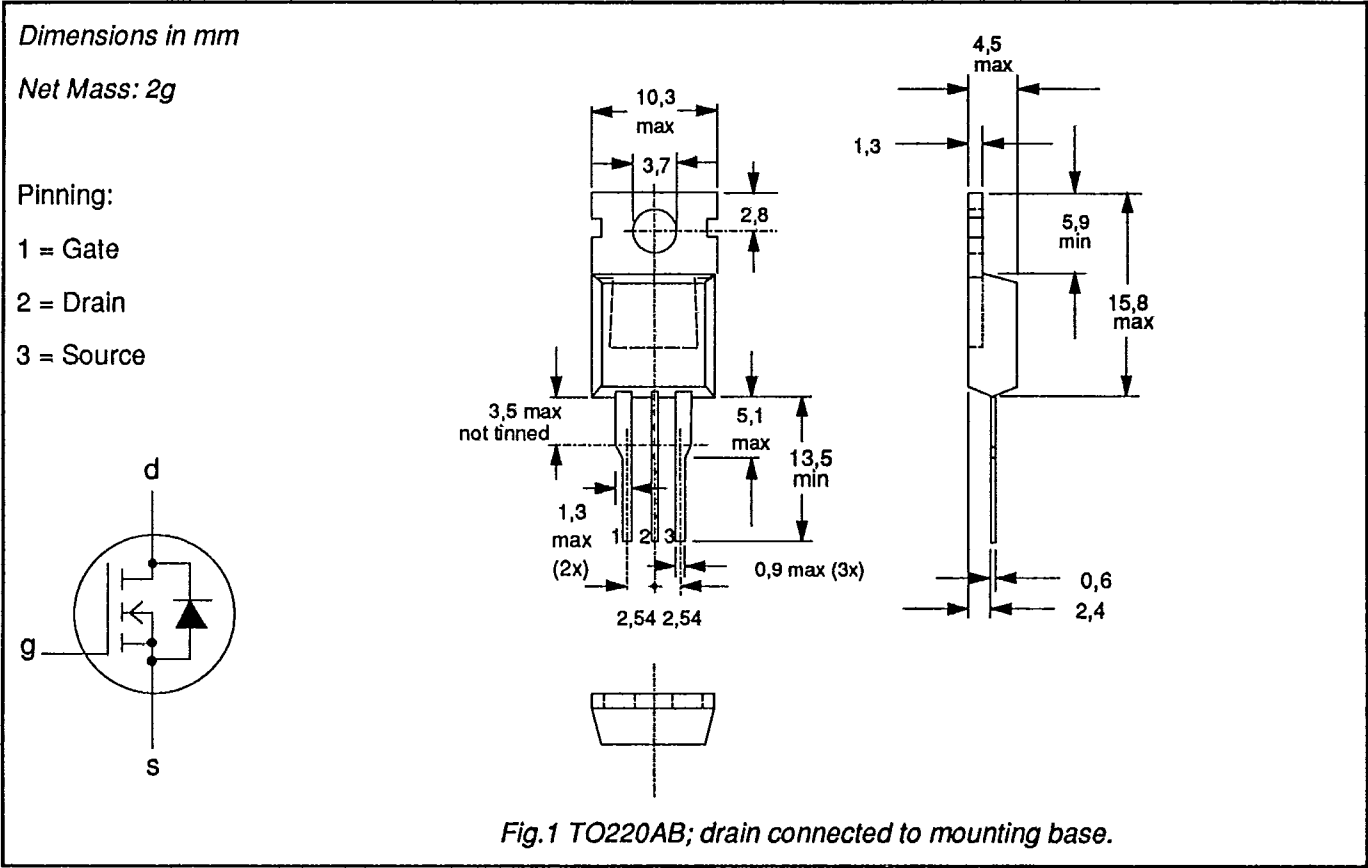
GENERAL DESCRIPTION

QUICK REFERENCE DATA

N-channel enhancement mode field-effect power transistor in a plastic envelope.
The device is intended for use in Switched Mode Power Supplies (SMPS), motor control, welding, DC/DC and AC/DC converters, and in general purpose switching applications.

SYMBOL	PARAMETER	MAX.	MAX.	UNIT
	BUK457	-400A	-400B	
V_{DS}	Drain-source voltage	400	400	V
I_D	Drain current (DC)	13	11	A
P_{tot}	Total power dissipation	150	150	W
$R_{DS(ON)}$	Drain-source on-state resistance	0.4	0.5	Ω

MECHANICAL DATA



- Notes
1. Observe the general handling precautions for electrostatic-discharge sensitive devices (ESDs) to prevent damage to MOS gate oxide.
 2. Accessories supplied on request: refer to Mounting instructions for TO220 envelopes.

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RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{DS}	Drain-source voltage	-	-	400	V
V_{DGR}	Drain-gate voltage	$R_{GS} = 20 \text{ k}\Omega$	-	400	V
$\pm V_{GS}$	Gate-source voltage	-	-	30	V
I_D	Drain current (DC)	$T_{mb} = 25 \text{ }^\circ\text{C}$	-	-400A 13	A
I_D	Drain current (DC)	$T_{mb} = 100 \text{ }^\circ\text{C}$	-	8.2	A
I_{DM}	Drain current (pulse peak value)	$T_{mb} = 25 \text{ }^\circ\text{C}$	-	52	A
P_{tot}	Total power dissipation	$T_{mb} = 25 \text{ }^\circ\text{C}$	-	150	W
T_{stg}	Storage temperature	-	-55	150	$^\circ\text{C}$
T_j	Junction Temperature	-	-	150	$^\circ\text{C}$

THERMAL RESISTANCES

From junction to mounting base	$R_{thj-mb} = 0.83 \text{ K/W}$
From junction to ambient	$R_{thj-a} = 60 \text{ K/W}$

STATIC CHARACTERISTICS

 $T_{mb} = 25 \text{ }^\circ\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 0.25 \text{ mA}$	400	-	-	V
$V_{GS(TH)}$	Gate threshold voltage	$V_{DS} = V_{GS}; I_D = 1 \text{ mA}$	2.1	3.0	4.0	V
I_{DSS}	Zero gate voltage drain current	$V_{DS} = 400 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$	-	2	20	μA
I_{DSS}	Zero gate voltage drain current	$V_{DS} = 400 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 125 \text{ }^\circ\text{C}$	-	0.1	1.0	mA
I_{GSS}	Gate source leakage current	$V_{GS} = \pm 30 \text{ V}; V_{DS} = 0 \text{ V}$	-	10	100	nA
$R_{DS(ON)}$	Drain-source on-state resistance	$V_{GS} = 10 \text{ V}; I_D = 6.5 \text{ A}$	-	0.35	0.4	Ω
		BUK457-400A	-	0.45	0.5	Ω
		BUK457-400B	-			

DYNAMIC CHARACTERISTICS

 $T_{mb} = 25 \text{ }^\circ\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
g_{fs}	Forward transconductance	$V_{DS} = 25 \text{ V}; I_D = 6.5 \text{ A}$	5.0	8.0	-	S
C_{iss}	Input capacitance	$V_{GS} = 0 \text{ V}; V_{DS} = 25 \text{ V}; f = 1 \text{ MHz}$	-	1500	1800	pF
C_{oss}	Output capacitance		-	170	270	pF
C_{rss}	Feedback capacitance		-	70	120	pF
t_{don}	Turn-on delay time	$V_{DD} = 30 \text{ V}; I_D = 2.8 \text{ A}; V_{GS} = 10 \text{ V}; R_{GS} = 50 \text{ }\Omega;$	-	20	40	ns
t_r	Turn-on rise time	$R_{gen} = 50 \text{ }\Omega$	-	60	90	ns
t_{doff}	Turn-off delay time		-	200	250	ns
t_f	Turn-off fall time		-	75	90	ns
L_d	Internal drain inductance	Measured from contact screw on tab to centre of die	-	3.5	-	nH
L_d	Internal drain inductance	Measured from drain lead 6 mm from package to centre of die	-	4.5	-	nH
L_s	Internal source inductance	Measured from source lead 6 mm from package to source bond pad	-	7.5	-	nH

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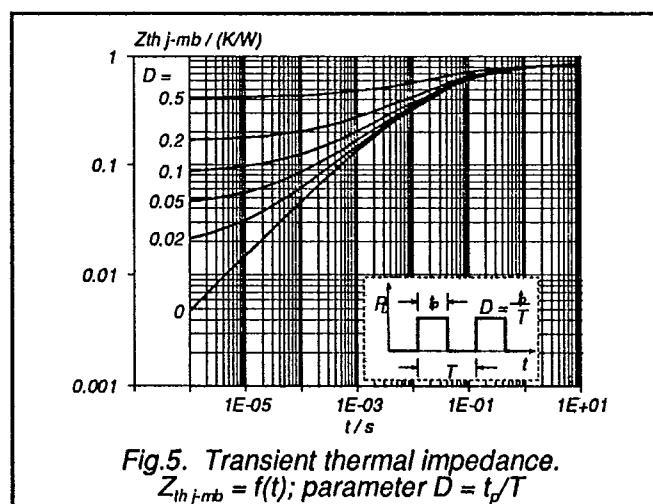
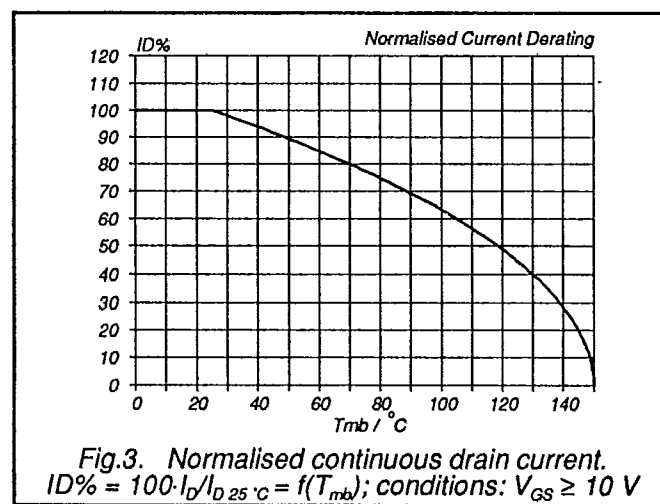
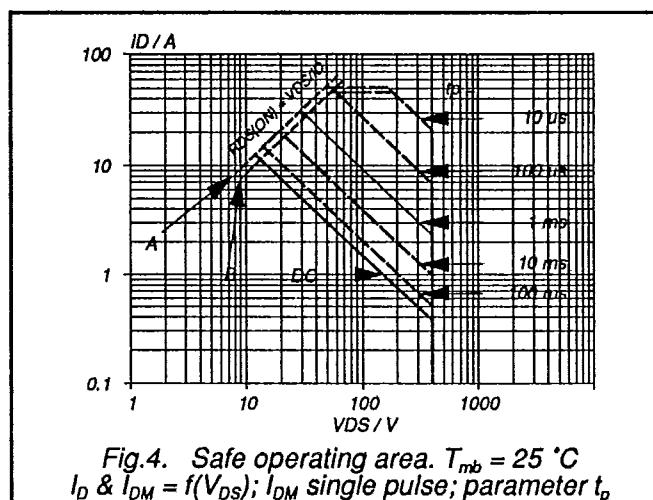
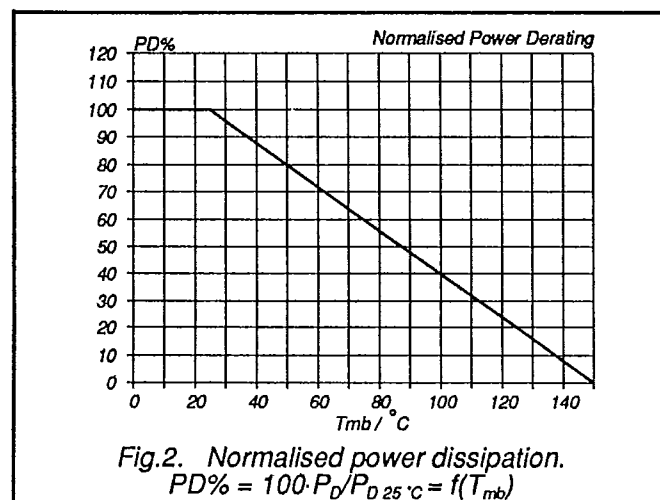
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REVERSE DIODE RATINGS AND CHARACTERISTICS

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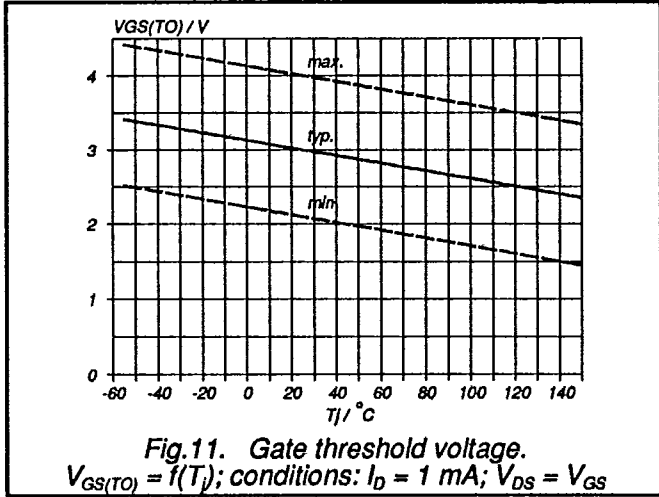
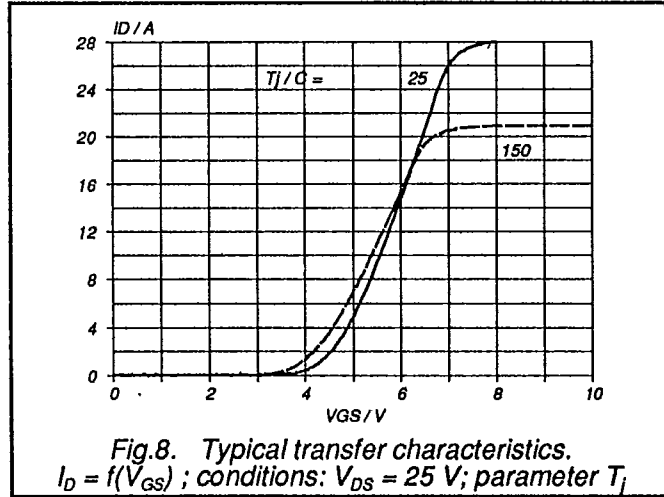
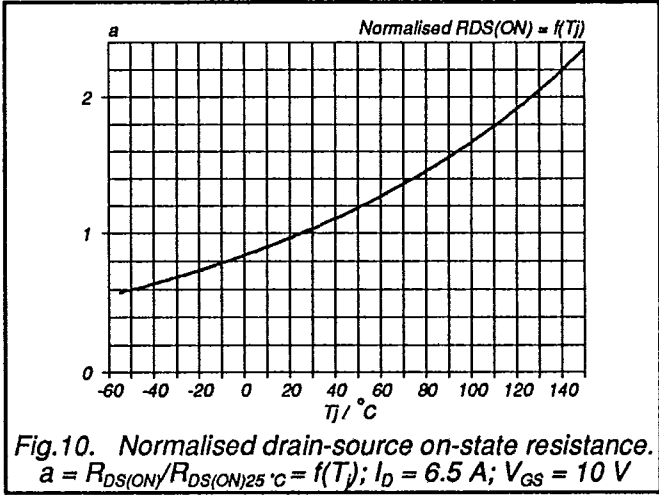
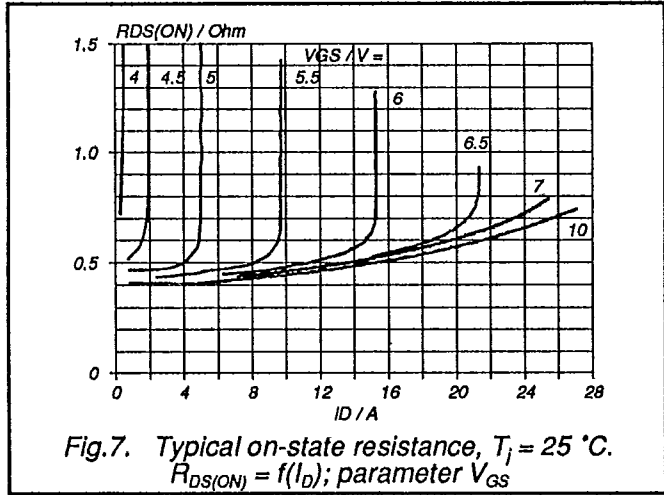
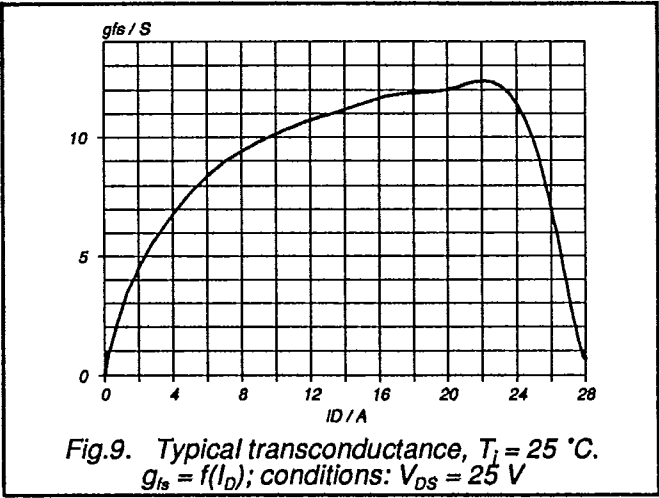
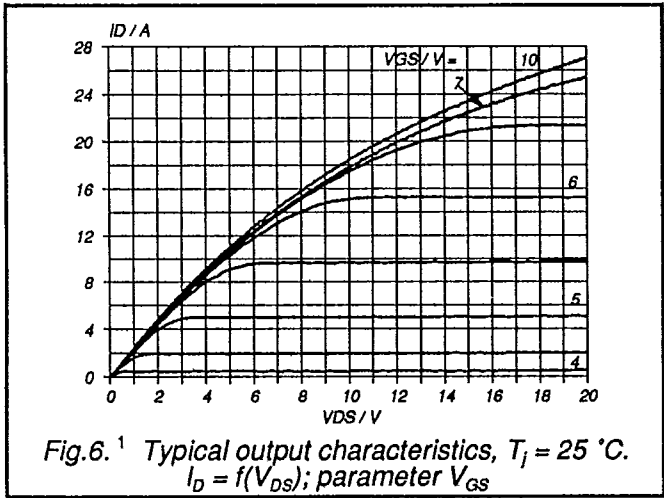
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_{DR}	Continuous reverse drain current	-	-	-	13	A
I_{DRM}	Pulsed reverse drain current	-	-	-	52	A
V_{SD}	Diode forward voltage	$I_F = 13\text{ A}; V_{GS} = 0\text{ V}$	-	1.1	1.4	V
t_{rr}	Reverse recovery time	$I_F = 13\text{ A}; -di_F/dt = 100\text{ A}/\mu\text{s}; V_{GS} = 0\text{ V}; V_R = 100\text{ V}$	-	500	-	ns
Q_{rr}	Reverse recovery charge	$I_F = 13\text{ A}; -di_F/dt = 100\text{ A}/\mu\text{s}; V_{GS} = 0\text{ V}; V_R = 100\text{ V}$	-	6.0	-	μC



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